

LM5066IEVM-626 Evaluation Module (EVM)

This user's guide describes the LM5066I EVM (LM5066IEVM-626). LM5066IEVM-626 contains evaluation and reference circuitry for the LM5066I. The LM5066I device combines a high performance hot swap controller with a PMBus™ compliant SMBus/I²C interface to accurately measure, protect, and control the electrical operating conditions of systems connected to a backplane power bus.

Contents

1	Introduction	3
	1.1 Features	3
	1.2 Applications	3
	1.3 Electrical Specifications	3
2	Schematic	4
3	General Configuration and Description	5
	3.1 Physical Access	5
	3.2 Equipment Setup	6
4	Operation	6
5	Test Results	7
6	Getting Started	11
	6.1 Hardware Setup Steps	11
	6.2 Device Evaluation	11
	6.3 GUI Event Log	13
	6.4 Plotting Telemetry Data	14
	6.5 Configuring the LM5066I Device	14
	6.6 Customizing the Design	16
7	Layout Guidelines	18
8	Board Layout	20
9	Bill of Materials	23

List of Figures

1	Startup Waveform	7
2	Startup into Short Performance	7
3	Oversvoltage Performance	8
4	Undersvoltage Waveform	8
5	Overload Performance	9
6	Load Transient into Overload Performance	9
7	Hot Short on Vout (Zoomed Out)	10
8	Hot Short on Vout (Zoomed In)	10
9	Device Selector	11
10	Initial GUI Screen	12
11	LM5066I Block-Level Representation	12
12	LM5066I Telemetry Display Options	13
13	LM5066I GUI With the Telemetry Plotting Tool Enabled	14
14	Device Configuration Panel	15
15	LM5066I Design Tool	16
16	Recommended Board Connector Design	18

17	Sense Resistor Connections.....	19
18	Top Assembly.....	20
19	Top Layer.....	20
20	Internal Layer 1.....	21
21	Internal Layer 2.....	21
22	Bottom Layer.....	22

List of Tables

1	LM5066IEVM-626 Electrical and Performance Specifications at 25°C.....	3
2	Connector Functionality.....	5
3	Test Points.....	5
4	Switches.....	6
5	LM5066IEVM-626 BOM.....	23

1 Introduction

The LM5066IEVM-626 evaluation board provides the design engineer with a fully functional intelligent monitoring and protection controller board designed for positive voltage systems. This user's guide describes the various functions of the board, how to test and evaluate it, and how to use the GUI design tool to change the components for a specific application. To use the advanced telemetry and monitoring capabilities of this device, the user must install the Intelligent Power Manager GUI; however, the LM5066I is capable of acting as a hot-swap and protection circuit without any software installation. For the latest software information, check the LM5066I High Voltage System Power Management and Protection IC with PMBus data sheet ([SNVS950](#)).

1.1 Features

- Programmable current limiting and power limiting for complete SOA protection
- Programmable fault timer to eliminate nuisance shutdowns
- Programmable undervoltage and overvoltage protection
- Programmable power good indicator
- Programmable auto-retry or latch options
- Fully Node Manager 2.0 and 2.5 compliant with I²C/SMBus interface and PMBus compliant command structure
- Real-time monitoring of VIN, VOUT, IIN, PIN, and VAUX with 12-bit resolution and 1-kHz sampling rate

1.2 Applications

- Any live backplane insertion application
 - Servers
 - Telecommunications

1.3 Electrical Specifications

Table 1. LM5066IEVM-626 Electrical and Performance Specifications at 25°C

Characteristic	LM5066IEVM-626
Input voltage range (operating)	40 to 60 V
Current operating	20 A
Power limit (nom)	239 W
Current limit (nom)	26 A
Fault timer (nom)	520 μs
UVLO rising (nom)	38 V
UVLO falling (nom)	35 V
Overvoltage rising (nom)	65 V
Overvoltage falling (nom)	63 V
PG threshold – vout rising (nom)	38 V
PG threshold – vout falling (nom)	35 V
Pass "Hot-Short" on output	Yes
Pass "Start into short"?	Yes
Is the load off until PG asserted?	Yes
Can a hot board be plugged back in?	Yes

Windows is a registered trademark of Microsoft Corporation.
PMBus is a trademark of SMIF, Inc.

3 General Configuration and Description

3.1 Physical Access

Table 2 lists the LM5066IEVM-626 connector and functionality, Table 3 describes the test point availability, and Table 4 describes the switch functionality.

Table 2. Connector Functionality

Connector	Label	Description
J1	VIN	Power bus input. Apply bus input voltage between J1 and J2.
J2	GND	Power bus input return connector. Apply bus input voltage between J1 and J2.
J3	VOUT	Switched bus output. Apply the load between J3 and J4.
J4	GND	Switch bus output return connector. Apply the load between J3 and J4.
J5		PMBus interface

Table 3. Test Points

Test Point	Label	Description
TP1	VIN	Positive supply input
TP2	VINK	Positive supply Kelvin sense pin on sense resistor
TP3	SENSEK	Sense Kelvin sense pin on sense resistor
TP4	SENSEK	Sense pin test point
TP5	GATE	Gate drive output
TP6	VOUT_S	Output voltage at the pass FET
TP7	VOUT	Output voltage at the load
TP8	FB	Power Good feedback
TP9	PG	Power Good indicator
TP10	TIMER	Timing capacitor voltage
TP11	VREF	Internal reference voltage
TP12	VAUX	Auxiliary ADC input
TP13	EN	UVLO/EN pin voltage
TP14	OVLO	OVLO pin voltage
TP15, TP19, TP20, TP21	GND	Circuit ground
TP16	SDA	SMBus input/output
TP17	SCL	SMBis clock
TP18	SMBA	SMBUS alert line (active low)
TP22	VDD	Internal sub-regulator 4.85-V output
TP23	RETRYB	Fault retry input
TP24	CL	Current limit range
TP25	ADR0	SMBus address line 0
TP26	ADR1	SMBus address line 1
TP27	ADR2	SMBus address line 2

Table 4. Switches

Switch	Label	Description
S1	EN	Enable and disable of the hotswap
SW1	RETRY	Fault retry input
SW2	CL	Current limit range
SW3	ADR0	SMBus address line 0
SW4	ADR1	SMBus address line 1
SW5	ADR2	SMBus address line 2

3.2 Equipment Setup

1. Set the input power supply voltage to the desired operating input voltage.
2. Turn the power supply off.
3. Connect the positive voltage lead from the power supply to J1 (VIN). Connect the ground lead from the power supply to J2 (GND).
4. Place a voltmeter or oscilloscope probe across J3 and J4 (VOUT).

4 Operation

1. Turn on the power supply.
2. Enable S1 ON.
3. Vary the input voltage and add load current as necessary for test purposes.
4. Apply fault conditions to observe fault performance as necessary.

5 Test Results

This section provides typical performance waveforms for the LM5066IEVM-626 with $V_{IN} = 48\text{ V}$ at no load (unless otherwise specified). Actual performance data is affected by measurement techniques and environmental variables; therefore, these curves are presented for reference and may differ from actual results obtained.

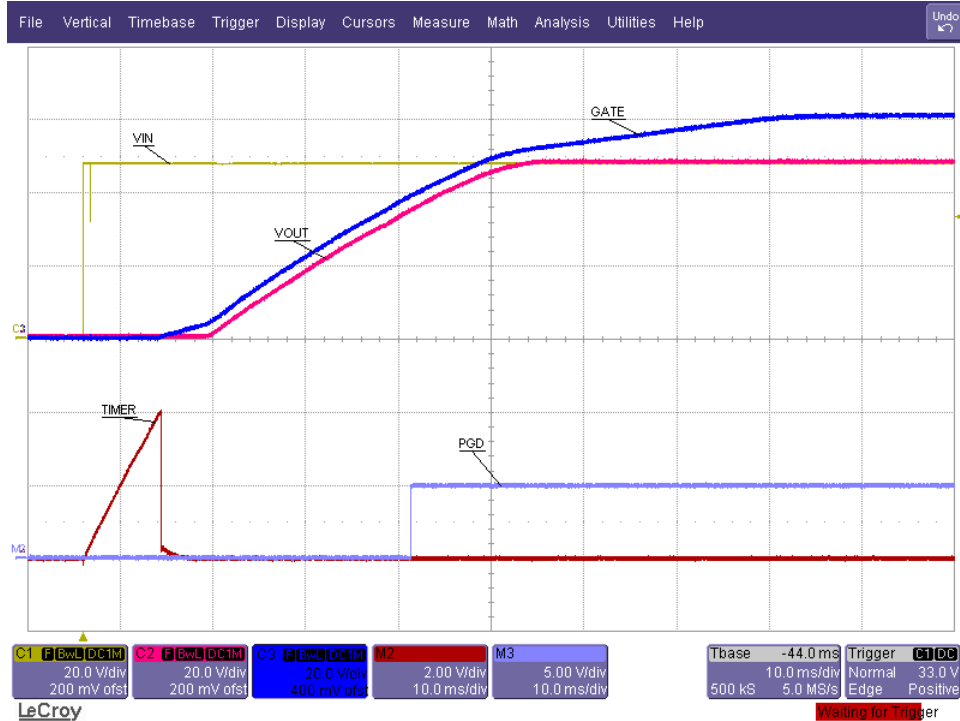


Figure 1. Startup Waveform



Figure 2. Startup into Short Performance

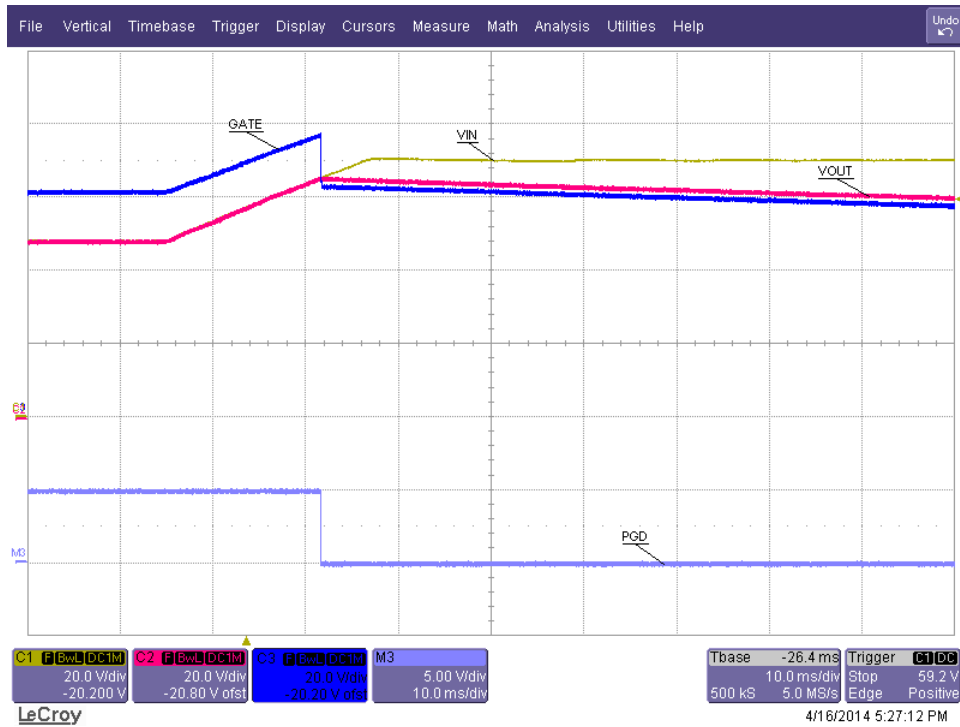


Figure 3. Overvoltage Performance

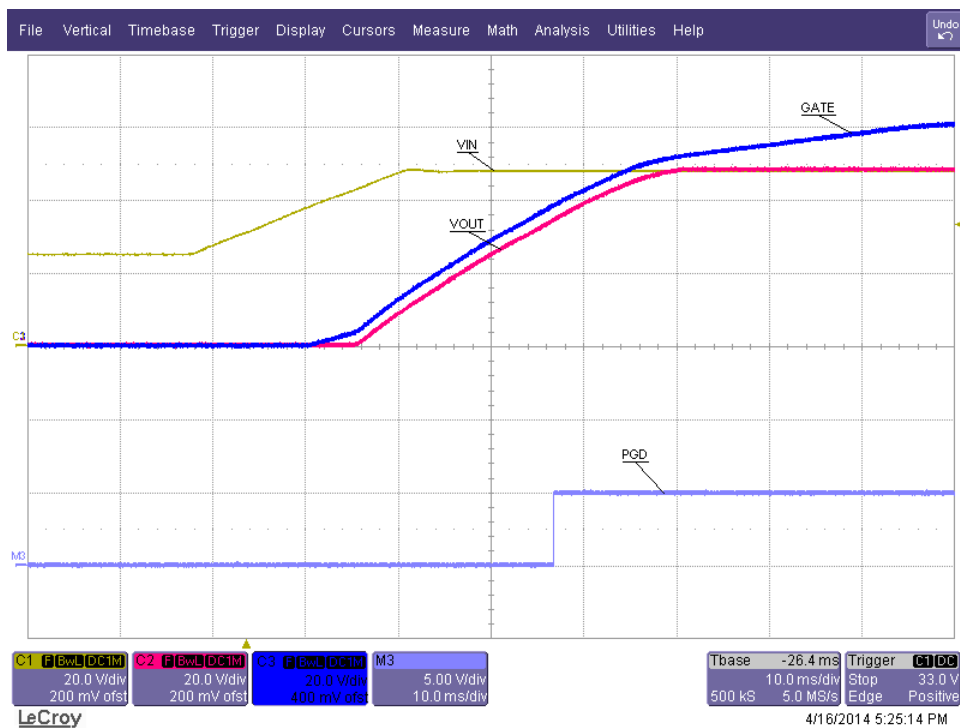


Figure 4. Undervoltage Waveform

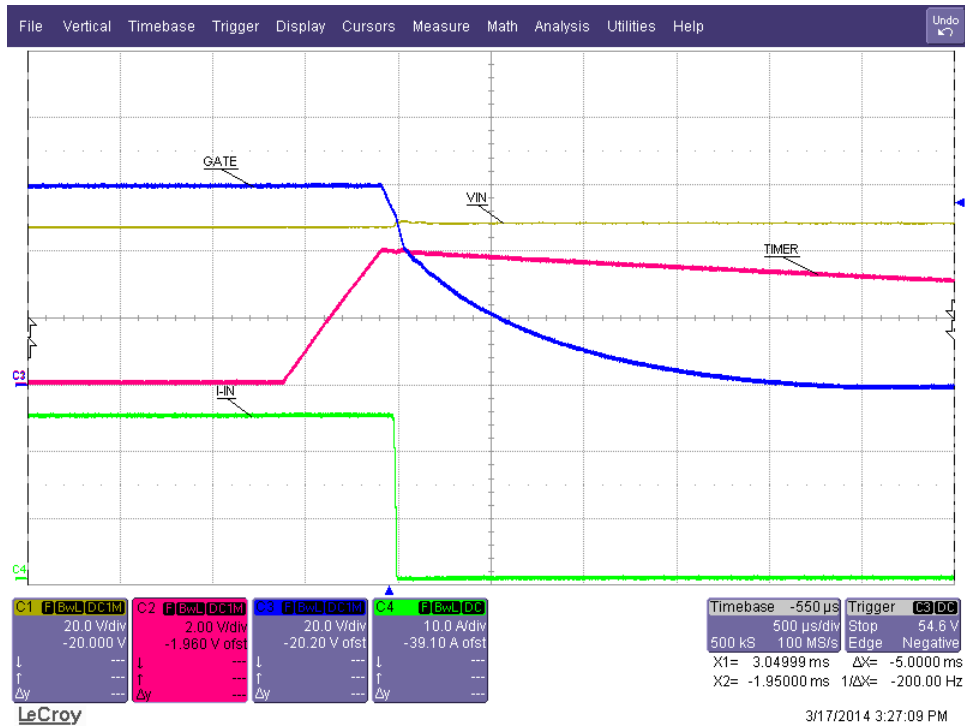


Figure 5. Overload Performance

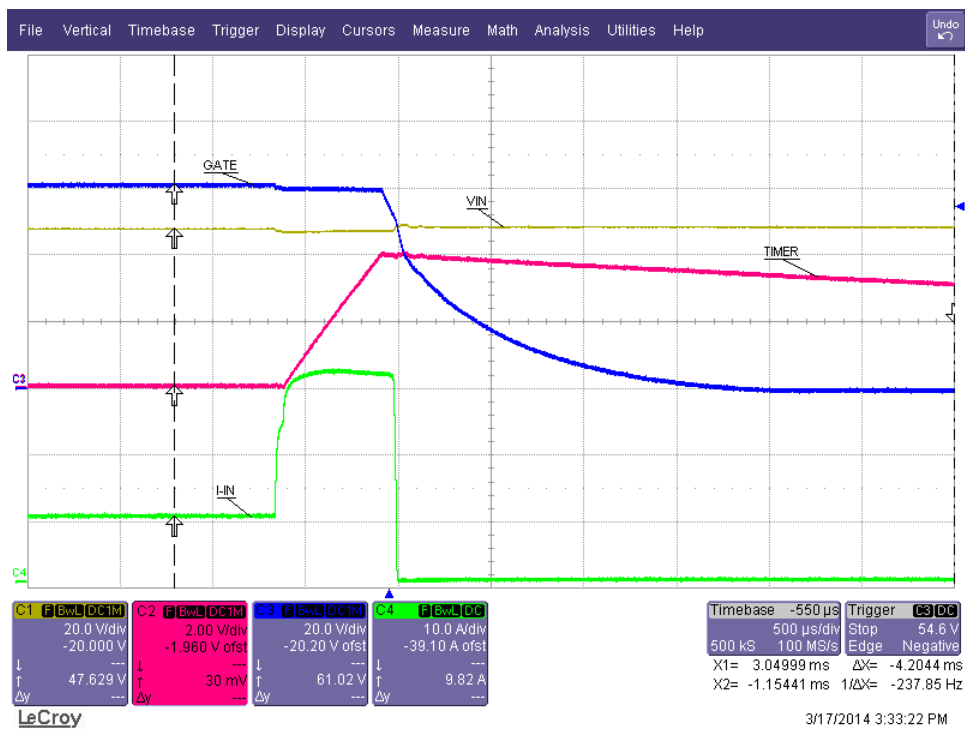


Figure 6. Load Transient into Overload Performance



Figure 7. Hot Short on Vout (Zoomed Out)

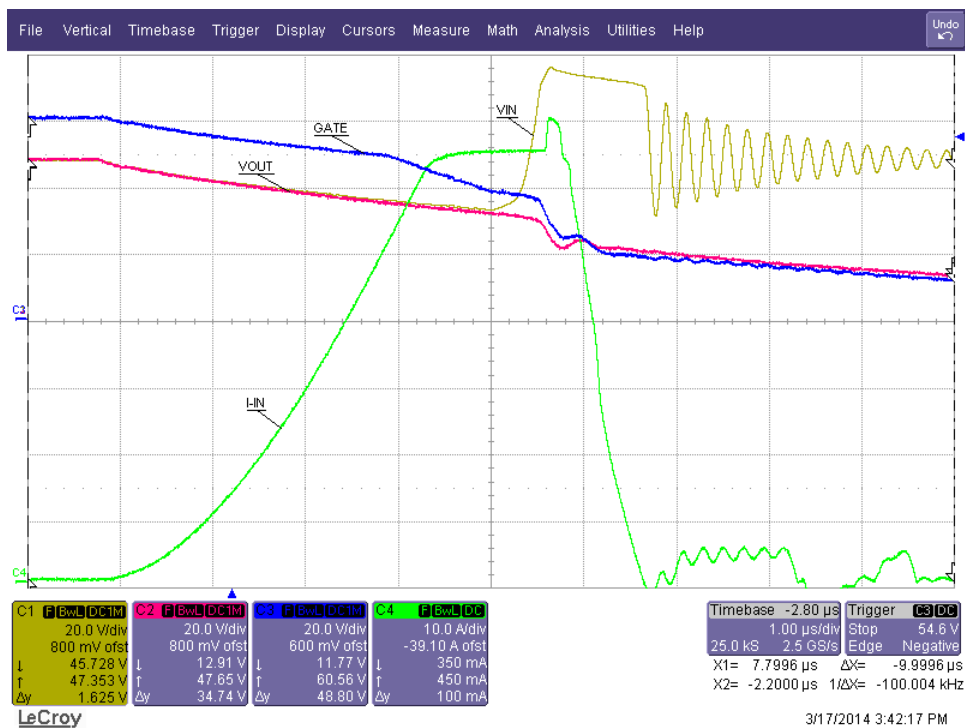


Figure 8. Hot Short on Vout (Zoomed In)

6 Getting Started

The LM5066IEVM is supplied with the PMBus address set to 0x40 as dictated by the jumper configuration of the ADR0, ADR1, and ADR2 jumper connections.

The first step to evaluate the telemetry features of LM5066I is to install the GUI software. The software can be found under software on the [product page](#). This file should be executed on a PC running Windows® XP or later to install the software.

6.1 Hardware Setup Steps

1. Connect the input supply to the VIN (J1) and GND (J2) banana plugs.
2. Connect the load to the VOUT (J3) and GND (J4) banana plugs.
3. Connect the FTDI Dongle to the 10-pin connector on the left side of the board to J5.
4. Connect the supplied mini USB cable from the FTDI dongle to an USB port on a PC.

When the FTDI dongle is connected for the first time, the user will be prompted to install the device drivers. For the most current driver installation procedure, refer to the README.TXT file in the installation directory.

For a hot swap circuit to function reliably, TI recommends a low inductance connection to the input supply. Its purpose is to minimize voltage transients which occur when the load current changes or is shut off. If the user is not careful, wiring inductance in the supply lines will generate a voltage transient at the input which can exceed the absolute maximum rating of the LM5066I, resulting in its destruction. To protect against such voltage transients, TVS device D2 is provided to clamp the voltage at the input to within safe operating limits. Likewise, Schottky diode D3 is provided on the output to clamp the output from going excessively negative during short circuit events.

6.2 Device Evaluation

After configuring the hardware connections, apply an input voltage of 48 V to the device. The current hardware configuration allows the LM5066I device to work from 40- to 60-V input supply voltage; however, this guide assumes an input voltage of 48 V. Launch the GUI by going to the Windows Start menu → All Programs → PMBManager-x.xxxxx → PMBusManager. A pulldown menu should come up with a list of devices populated. Select the "LM5066" option as shown in [Figure 9](#).

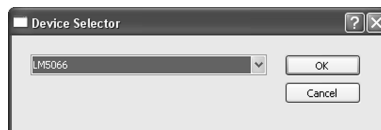


Figure 9. Device Selector

The device should be detected on the PMBus, and the initial load screen should appear as shown in [Figure 10](#).

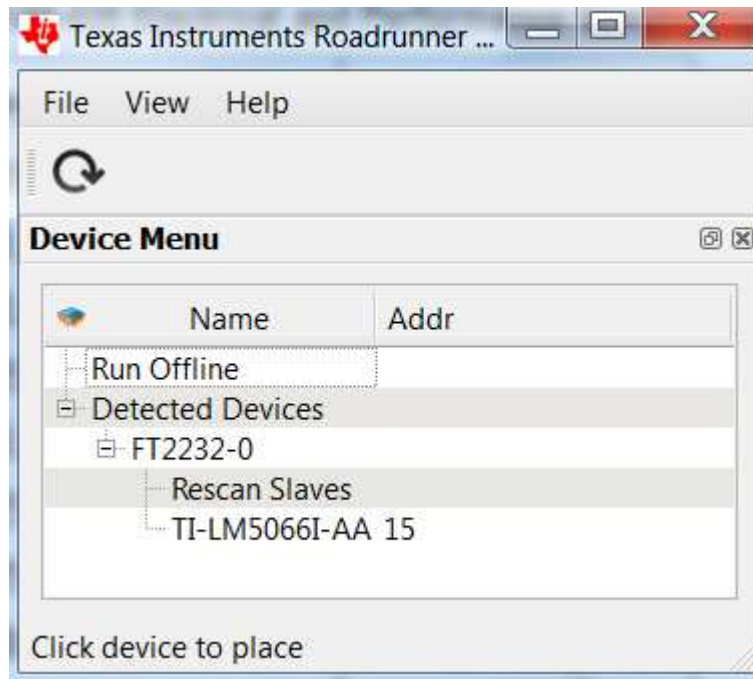


Figure 10. Initial GUI Screen

If a device is not detected, there is an option to rescan, ignore, or exit the GUI. If the hardware is intended to be connected, check the USB connection to the PCB, FTDI connection to the evaluation module, and verify that the power is present on the evaluation PCB by measuring the voltage between the V_{IN_S} and V_{IN_GND} test points. Ignoring the detection message allows use of the integrated design tool without the hardware connected.

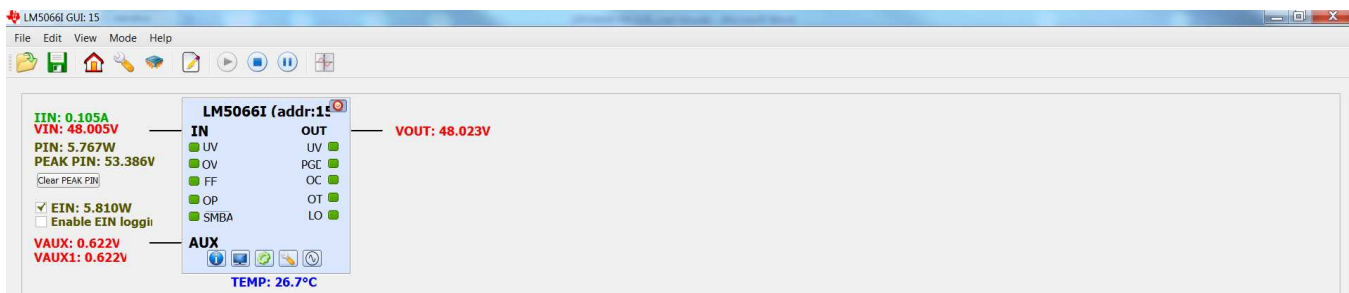


Figure 11. LM5066I Block-Level Representation

Click on the detected device ID (TI-LM5066I-AA) to display a block level representation of the device as shown in [Figure 11](#). The block level view of the device provides a display of all the telemetry data as well as most of the faults and warnings supported by the device. The faults and warnings supported are generally associated with an invalid input or output condition.

The faults shown on the left side of the block representation are generally associated with the input. These include input under-voltage (UV), input over-voltage (OV), FET fail (FF), and input over-power (OP). The SMBus alert status, **SMBA**, is also shown on the left side and will turn red during any warning or fault event. To facilitate the evaluation of the device, SMBus alerts are automatically cleared by the GUI.

The faults shown on the right side of the block representation are associated with the output. These include output over-voltage (OV), power good status (PGD), output over-current (OC), and over-temperature (OT). There is also an indicator if the output is in the latched off state (LO). The device latches the output off after the number of user-programmable retries is exceeded. To clear the latched off condition, the output can be toggled off and on by the red power button located in the top right of the LM5066I block representation.

To show a repetitive update of the device telemetry and status, click the Play button at the top of the screen. The Play button starts an active telemetry log of the gathered data. Clicking the Stop button stops the telemetry collection and allows for the log file to be viewed and saved. The Pause button pauses both the displaying and logging of telemetry information.

To enable or disable specific telemetry, click the Display Options button on the block representation and choose the desired telemetry to display (see [Figure 12](#)).



Figure 12. LM5066I Telemetry Display Options

Note that turning off the various warning options does not mask the faults from issuing an SMBus alert; by turning off warning options, the selected warnings are just not displayed if they occur. The device is capable of masking various faults, and this functionality can be setup in the device configuration panel.

6.3 GUI Event Log

A GUI event log is provided to keep track of GUI configuration changes and device fault events. To display the event log, select View from the main menu bar, then Telemetry Data Log. The event log appears on the left side of the main GUI window. The event log can be detached and expanded if desired by left clicking on the event log window and dragging the window with the mouse to the desired location.

6.4 Plotting Telemetry Data

To enable telemetry data plots, click on the sine wave button located on the LM5066I block representation. After enabling the telemetry, a prompt appears requesting entry of the GUI sample interval, plot interval, and plot depth. For most cases, the default rates and depths are acceptable. The plotting tool allows the user to select the desired data to be plotted. Up to two different parameters can be plotted at the same time as shown in Figure 13.

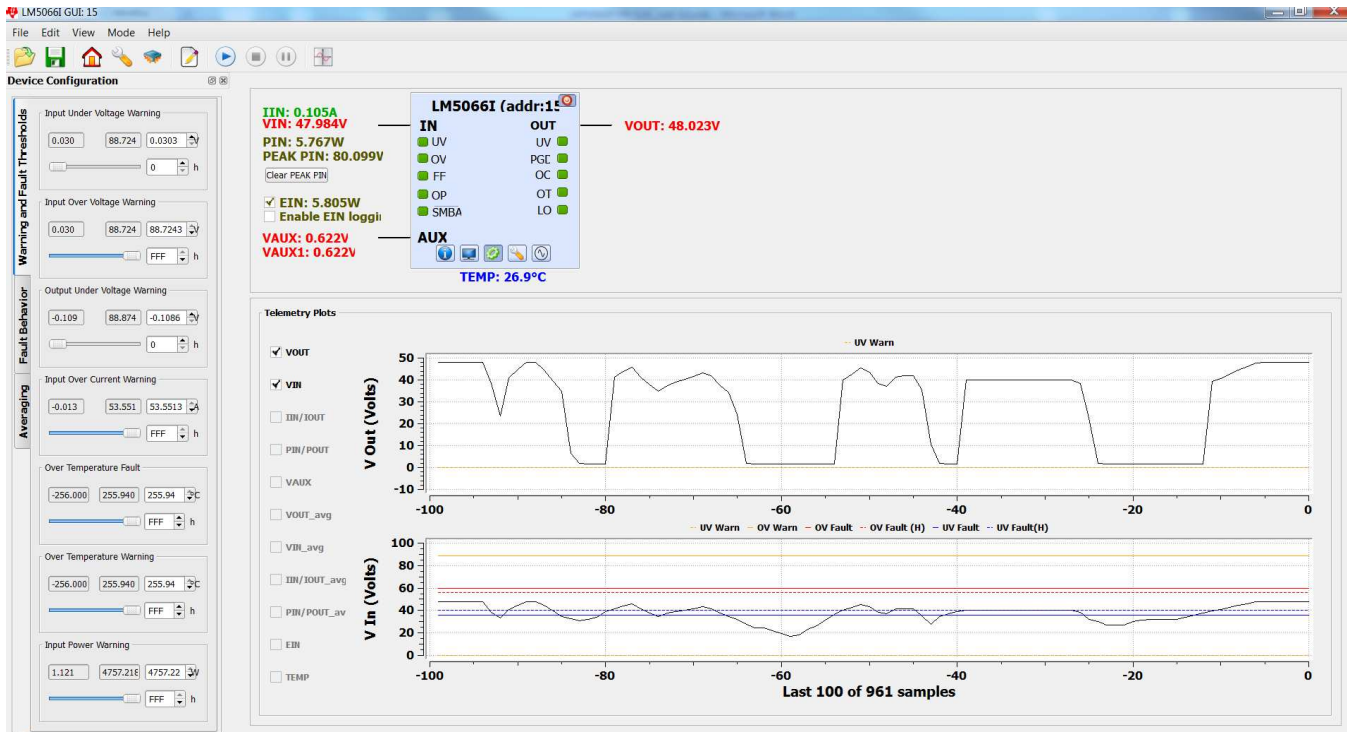


Figure 13. LM5066I GUI With the Telemetry Plotting Tool Enabled

Telemetry data is plotted as a black line that continually updates as the device is queried. In addition to the telemetry data, the relevant warning and fault thresholds are also plotted. Warning thresholds are shown as orange lines while fault thresholds are shown in red and blue.

From the Plot menu option in the main menu bar, the user can disable the plotting grid and the warning and fault lines.

6.5 Configuring the LM5066I Device

Warning thresholds, temperature fault threshold, protection ranges, fault masking, and averaging can be configured in the Device Configuration panel. This panel, shown in Figure 14, is enabled by clicking View → Device Configuration.

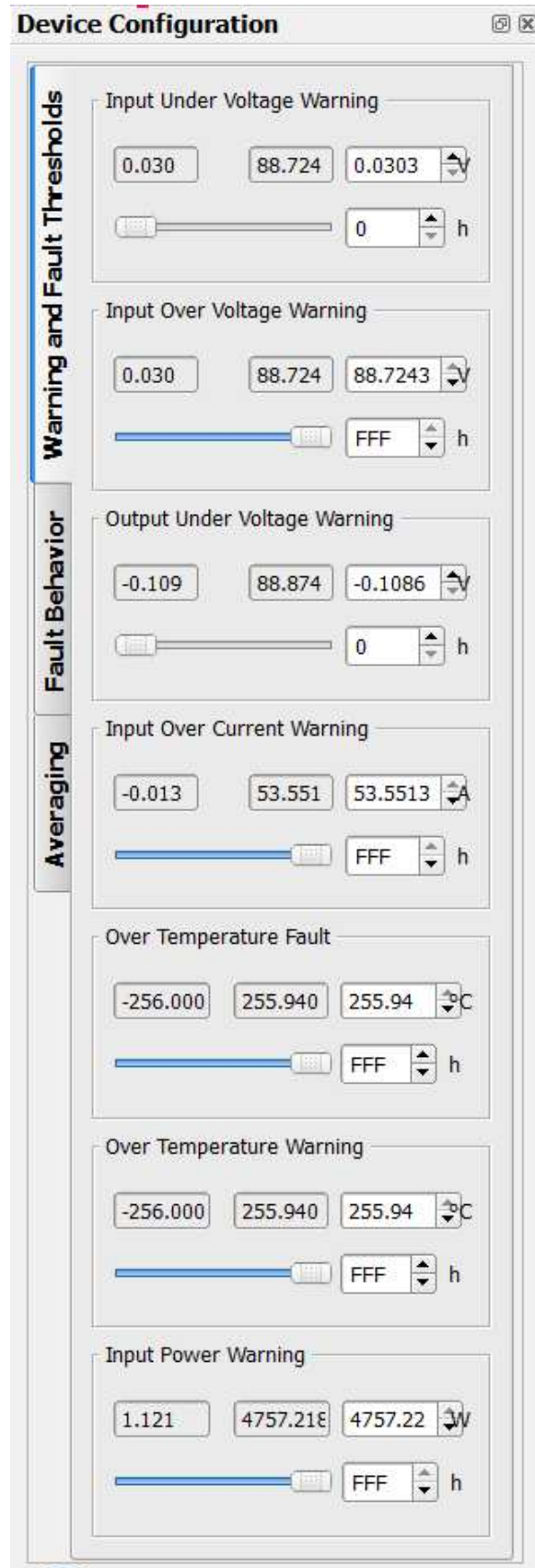


Figure 14. Device Configuration Panel

The Warning and Fault Threshold tab allows configuration of the input undervoltage, input overvoltage, output undervoltage, input overcurrent, input power, and overtemperature warnings. This tab also allows adjustment of the overtemperature fault threshold. The hardware design sets the fault threshold for the input over-voltage and under-voltage, current limit, power limit, and power good. Decimal values for the thresholds are shown in the text box located to the right of the slider bar. The hexadecimal value of the setting is located above the decimal values setting, which can be useful when developing software for this device.

The fault behavior tab allows the user to set the device fault configuration and fault masking. The fault configuration section allows the user to set the number of retries, as well as the circuit breaker and current limit thresholds. The number of retries can be set by the RETRY pin to be infinite or latched off. Through software, the number of retries can be set to 0 (latch-off), 1, 2, 4, 8, 16, or infinite. The software settings are independent of the hardware settings; however, if the power is cycled, the device defaults to values dictated by the hardware. Current limit power-up values are also set by the hardware. The values for current limit can be set to either 26 mV (CL = VDD) or 50 mV (CL = GND). The circuit breaker threshold can also be set in software to either 1.9x or 3.9x the current limit value through the software. Fault masking is possible for many of the device fault conditions. Fault conditions allow masking of both the MOSFET response and the SMBus alert signal. Note that if a fault occurs repeatedly while the MOSFET is masked, damage to the MOSFET may result. This feature is allowed primarily for debug purposes. Faults that do not shut off the MOSFET and only issue a SMBus alert, also allow masking of the alert. Note the power-up default setting for the Power Good signal is to mask the SMBus alert, in order to ensure that SMBus alert is not asserted immediately after power-up.

For convenience, the Device Configuration panel can be undocked by holding down the left mouse button while the cursor is at the top of the panel and dragging it to the desired location.

6.6 Customizing the Design

The GUI assumes the hardware configuration is set to default LM5066I evaluation board configuration. If any of the components are changed, the device hardware configuration needs to be updated in the Design Tool section. To open the design tool, click the Wrench button located on the LM5066I block representation, which will open the window displayed in Figure 15.

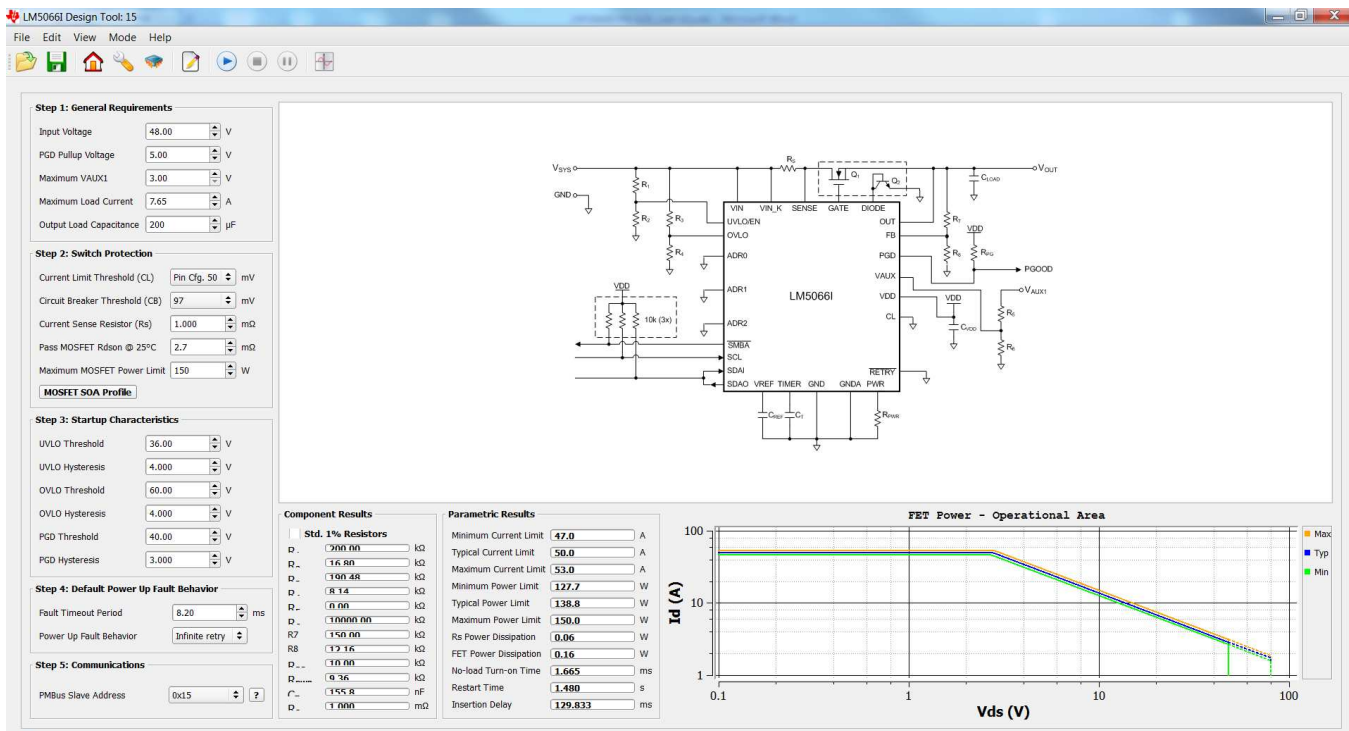


Figure 15. LM5066I Design Tool

Design inputs are keyed in on the left side following steps 1 through 5.

1. Enter the general operating conditions in step 1 of the design tool. These inputs help set bounds on the startup time and application voltage ranges.
2. Step 2 allows the user to tailor the MOSFET protection features to be specific to the target application. Current limit is pin-configurable and software-configurable, and circuit breaker is software-configurable. If the CL switch is used to set the current limit, ensure the GUI selection matches the pin-configurable CL bit setting on the board. By clicking on the MOSFET SOA Profile button, the user can select SOA data from several popular MOSFETs or enter the SOA data for the desired MOSFET. The resistor R_{PWR} can then be calculated to keep Q_1 or Q_3 , or both, within its SOA profile.
3. Step 3 allows the user to select the undervoltage lockout (UVLO) and overvoltage lockout (OVLO) values, and power good (PGD) thresholds. Note that with the correct values for R8, R9, R13, R14, and R3 and R7 installed, the LM5066I indicates a fault condition when the input or output voltages, or both, are outside of their programmed range.
4. Step 4 allows the user to set the fault time-out period and the fault response. The fault time-out should be set to be below the MOSFET SOA data for a given time. For example, if a design is done to adhere to the 10 ms pulsed MOSFET SOA data, the desired fault time-out must be less than 10 ms. The fault time-out time entered sets the value for C_T . It also sets the insertion delay and fault retry delay. The initial power-up retry behavior is also selected in this design step. Make sure to change the \overline{RETRY} switch to match the design tool schematic when changing the default retry setting.
5. In step 5, the user enters the desired PMBus address. Note changing the PMBus address of the device in step 5 does not change the device address, but shows how the address pins of the device need to be configured to achieve a desired address. After the ADR pin switches are configured for a particular address, power to the device needs to be cycled and the GUI restarted in order for the new address to take effect.

When invalid or incorrect inputs are given to the design tool, text associated with the faulty input turns red. Positioning the mouse cursor over the red text gives additional information about any design conflict.

Component and parametric results are shown to the right as well as the LM5066I safe operational area (SOA) chart. The SOA chart shows the minimum, typical, and maximum SOA protection areas for a given design. For a robust design, the SOA of the MOSFET used should be above the max protection SOA line for all operating areas.

After a design is complete, the design should be saved by selecting the File menu, then Save. After the hardware is modified to match the design, the GUI should be restarted and the hardware configuration file loaded right after the device is detected and placed. If the values in the design tool are different than the values on the board, erroneous telemetry and fault data are reported by the GUI. To return to the block view of the device, press the Home button located at the far left in the menu bar.

The design tool is also useful to calculate the PMBus coefficients. With the correct value for current sense resistor (R_2), the tool calculates the correct coefficients to scale the raw telemetry data. The coefficients can be viewed by selecting View from the main menu bar, and then selecting the PMBus Coefficient Editor. When the PMBus Coefficient Editor is opened, press the Get All button to show the currently used coefficients.

If desired, the results presented by the design tool can be calculated by hand using the equations provided in the data sheet. However, note the design tool calculates parameters factoring in worst-case tolerances, while the equations in the data sheet are based on typical thresholds.

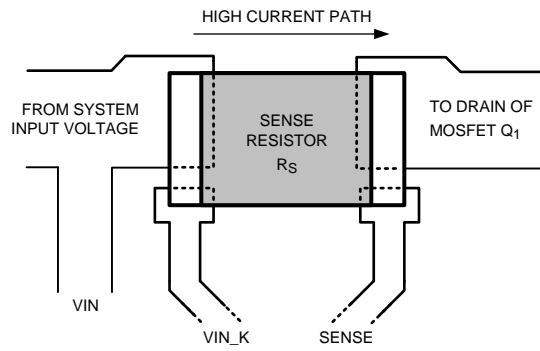


Figure 17. Sense Resistor Connections

8 Board Layout

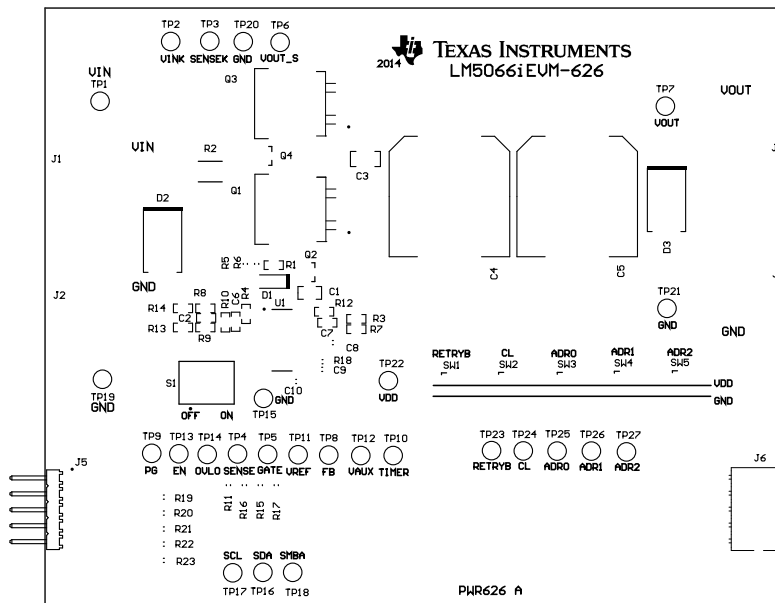


Figure 18. Top Assembly

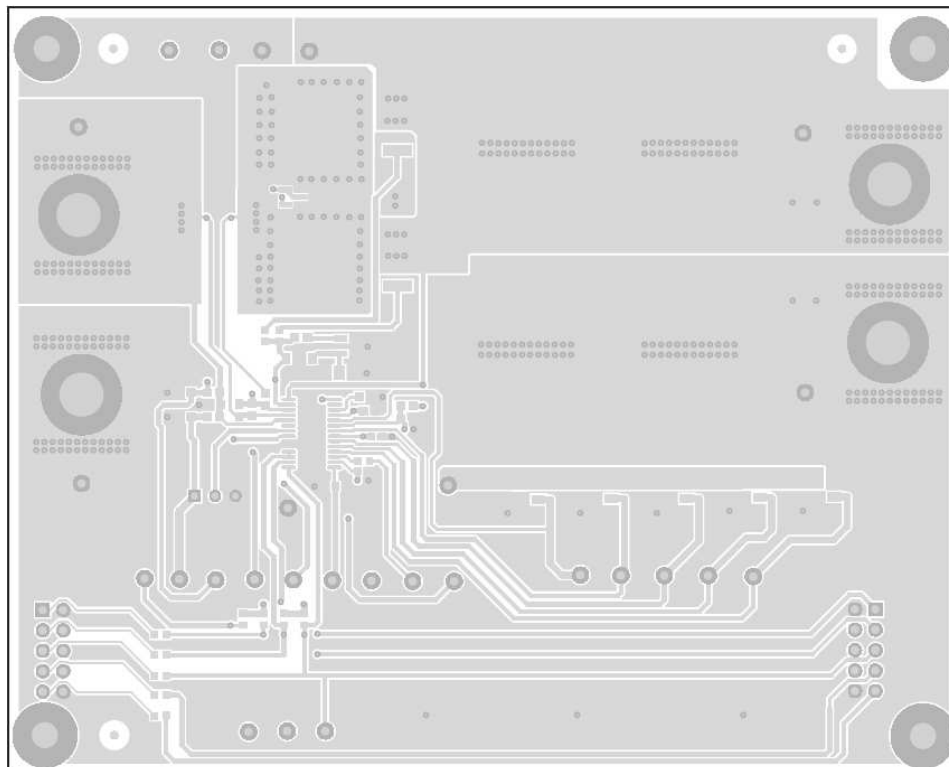


Figure 19. Top Layer

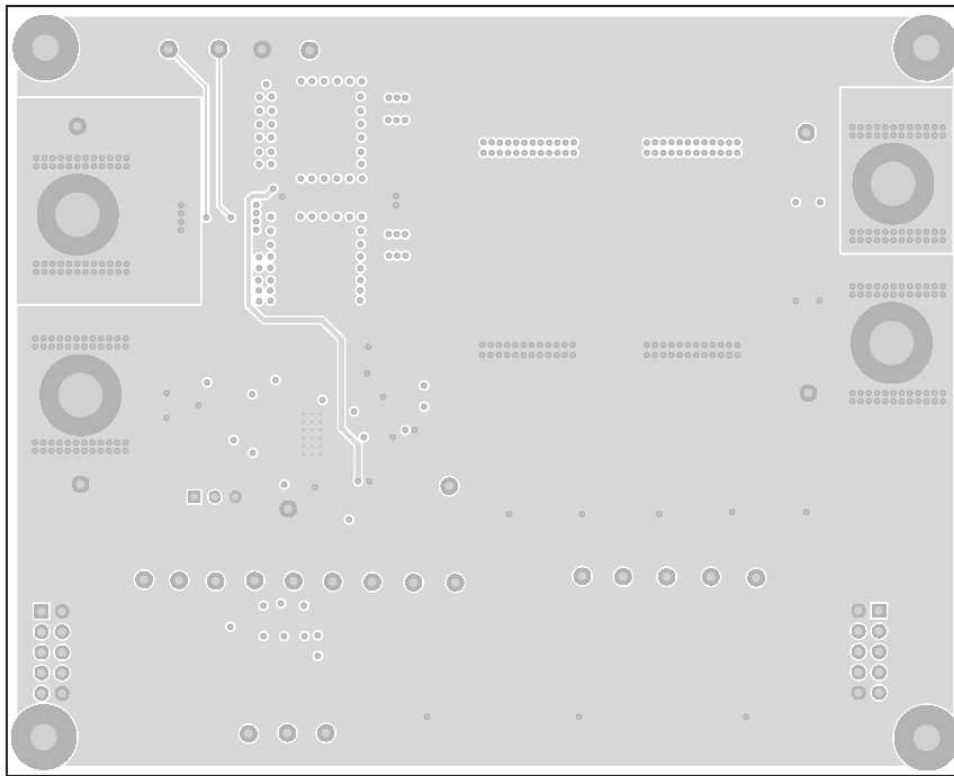


Figure 20. Internal Layer 1

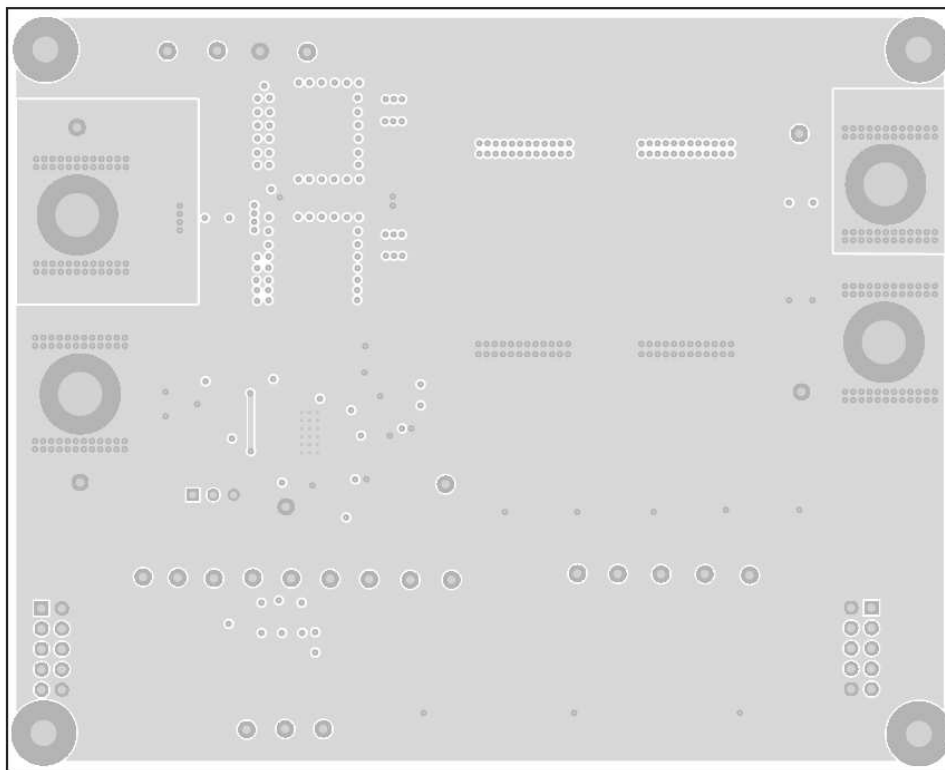


Figure 21. Internal Layer 2

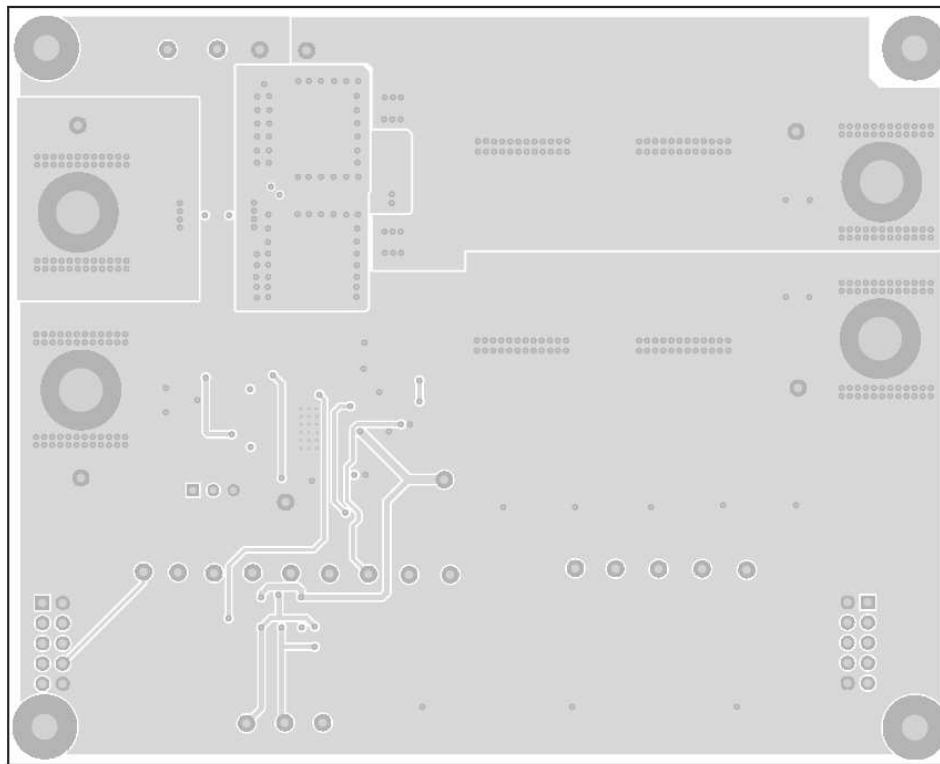


Figure 22. Bottom Layer

9 Bill of Materials

Table 5. LM5066IEVM-626 BOM

Designator	Qty	Value	Description	Package Reference	PartNumber	Manufacturer
C1	1	0.01uF	CAP, CERM, 0.01uF, 100V, ±5%, X7R, 0805	0805	08051C103JAT2A	AVX
C2	1	1000pF	CAP, CERM, 1000pF, 100V, ±5%, X7R, 0603	0603	06031C102JAT2A	AVX
C3	1	1uF	CAP, CERM, 1uF, 100V, ±10%, X7R, 1206	1206	GRM31CR72A105K A01L	MuRata
C4, C5	2	220uF	CAP, AL, 220uF, 100V, ±20%, 0.16 ohm, SMD	MN0	EMVH101GDA221M MN0S	Nippon Chemi-Con
C7	1	0.01uF	CAP, CERM, 0.01uF, 25V, ±10%, X7R, 0603	0603	GRM188R71E103K A01D	MuRata
C8, C10	2	1uF	CAP, CERM, 1uF, 16V, ±10%, X5R, 0603	0603	C0603C105K4PACT U	Kemet
C9	1	1000pF	CAP, CERM, 1000pF, 50V, ±10%, X7R, 0603	0603	C1608X7R1H102K	TDK
D1	1	100V	Diode, Ultrafast, 100V, 0.15A, SOD-123	SOD-123	1N4148W-7-F	Diodes Inc.
D2	1	60V	Diode, TVS, Uni, 60V, 5000W, SMC	SMC	5.0SMDJ60A	Littelfuse
D3	1	80V	Diode, Schottky, 80V, 3A, SMC	SMC	B380-13-F	Diodes Inc.
H1, H2, H3, H4	4		Standoff, Hex, 0.5"L #4-40 Nylon	Standoff	1902C	Keystone
H5, H6, H7, H8	4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw	NY PMS 440 0025 PH	B&F Fastener Supply
J1, J2, J3, J4	4		Standard Banana Jack, Uninsulated, 8.9mm		575-8	Keystone Electronics
J5	1		Header, 5x2, 100mil, R/A, TH	Header, 5x2, 100mil, R/A	TSW-105-08-G-D-RA	Samtec
Q1, Q3	2	100V	MOSFET, N-CH, 100V, 120A, DDPK	DDPAK	PSMN4R8-100BSEJ	NXP Semiconductor
Q2	1	0.5V	Transistor, PNP, 150V, 0.5A, SOT-23	SOT-23	MMBT5401LT1G	ON Semiconductor
Q4	1	0.2V	Transistor, NPN, 40V, 0.2A, SOT-23	SOT-23	CMPT3904 LEAD FREE	Central Semiconductor
R1	1	10k	RES, 10k ohm, 5%, 0.1W, 0603	0603	CRCW060310K0JN EA	Vishay-Dale
R2	1	0.001	RES, 0.001 ohm, 1%, 1W, 2512	2512	ERJ-M1WTF1M0U	Panasonic
R3, R9	2	150k	RES, 150k ohm, 1%, 0.1W, 0603	0603	CRCW0603150KFK EA	Vishay-Dale
R4, R18	2	0	RES, 0 ohm, 5%, 0.1W, 0603	0603	CRCW06030000Z0E A	Vishay-Dale
R5, R6	2	4.99	RES, 4.99 ohm, 1%, 0.1W, 0603	0603	CRCW06034R99FK EA	Vishay-Dale
R7	1	10.5k	RES, 10.5k ohm, 1%, 0.1W, 0603	0603	CRCW060310K5FK EA	Vishay-Dale
R8	1	95.3k	RES, 95.3k ohm, 1%, 0.1W, 0603	0603	CRCW060395K3FK EA	Vishay-Dale
R11	1	100k	RES, 100k ohm, 5%, 0.1W, 0603	0603	CRCW0603100KJN EA	Vishay-Dale
R12	1	28.0k	RES, 28.0k ohm, 1%, 0.1W, 0603	0603	CRCW060328K0FK EA	Vishay-Dale
R13	1	11.5k	RES, 11.5k ohm, 1%, 0.1W, 0603	0603	CRCW060311K5FK EA	Vishay-Dale

Table 5. LM5066IEVM-626 BOM (continued)

Designator	Qty	Value	Description	Package Reference	PartNumber	Manufacturer
R14	1	3.74k	RES, 3.74k ohm, 1%, 0.1W, 0603	0603	CRCW06033K74FK EA	Vishay-Dale
R15, R16, R17	3	10.0k	RES, 10.0k ohm, 1%, 0.1W, 0603	0603	CRCW060310K0FK EA	Vishay-Dale
R19, R20, R21, R22, R23	5	100	RES, 100 ohm, 1%, 0.1W, 0603	0603	CRCW0603100RFK EA	Vishay-Dale
S1	1		SWITCH TOGGLE SPDT 0.4VA 28V	6.8x23.1x8.8mm	B12AP	NKK Switches
SW1, SW2, SW3, SW4, SW5	5		Slide SW, SPDT 0.1A 50VDC	SW, 3.1x2.5x6 mm	CJS-1201TA	Copal Electronics
TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14, TP15, TP16, TP17, TP18, TP19, TP20, TP21, TP22, TP23, TP24, TP25, TP26, TP27	27	White	Test Point, TH, Miniature, White		5002	Keystone Electronics
U1	1		LM5066I/A High Voltage System Power Management and Protection IC with PMBus, PWP0028A	PWP0028A	LM5066IPWP	Texas Instruments
C6	0	1000pF	CAP, CERM, 1000pF, 100V, ±5%, X7R, 0603	0603	06031C102JAT2A	AVX
FID1, FID2, FID3	0		Fiducial mark. There is nothing to buy or mount.	Fiducial	N/A	N/A
J6	0		Connector, Receptacle, 100mil, 5x2, Gold plated, R/A, TH	5x2 R/A Header Receptacle	PPPC052LJBN-RC	Sullins Connector Solutions
R10	0	7.68	RES, 7.68 ohm, 1%, 0.1W, 0603	0603	CRCW06037R68FK EA	Vishay-Dale

ADDITIONAL TERMS AND CONDITIONS, WARNINGS, RESTRICTIONS, AND DISCLAIMERS FOR EVALUATION MODULES

Texas Instruments Incorporated (TI) markets, sells, and loans all evaluation boards, kits, and/or modules (EVMs) pursuant to, and user expressly acknowledges, represents, and agrees, and takes sole responsibility and risk with respect to, the following:

1. User agrees and acknowledges that EVMs are intended to be handled and used for feasibility evaluation only in laboratory and/or development environments. Notwithstanding the foregoing, in certain instances, TI makes certain EVMs available to users that do not handle and use EVMs solely for feasibility evaluation only in laboratory and/or development environments, but may use EVMs in a hobbyist environment. All EVMs made available to hobbyist users are FCC certified, as applicable. Hobbyist users acknowledge, agree, and shall comply with all applicable terms, conditions, warnings, and restrictions in this document and are subject to the disclaimer and indemnity provisions included in this document.
2. Unless otherwise indicated, EVMs are not finished products and not intended for consumer use. EVMs are intended solely for use by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.
3. User agrees that EVMs shall not be used as, or incorporated into, all or any part of a finished product.
4. User agrees and acknowledges that certain EVMs may not be designed or manufactured by TI.
5. User must read the user's guide and all other documentation accompanying EVMs, including without limitation any warning or restriction notices, prior to handling and/or using EVMs. Such notices contain important safety information related to, for example, temperatures and voltages. For additional information on TI's environmental and/or safety programs, please visit www.ti.com/esh or contact TI.
6. User assumes all responsibility, obligation, and any corresponding liability for proper and safe handling and use of EVMs.
7. Should any EVM not meet the specifications indicated in the user's guide or other documentation accompanying such EVM, the EVM may be returned to TI within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY TI TO USER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. TI SHALL NOT BE LIABLE TO USER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES RELATED TO THE HANDLING OR USE OF ANY EVM.
8. No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which EVMs might be or are used. TI currently deals with a variety of customers, and therefore TI's arrangement with the user is not exclusive. TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services with respect to the handling or use of EVMs.
9. User assumes sole responsibility to determine whether EVMs may be subject to any applicable federal, state, or local laws and regulatory requirements (including but not limited to U.S. Food and Drug Administration regulations, if applicable) related to its handling and use of EVMs and, if applicable, compliance in all respects with such laws and regulations.
10. User has sole responsibility to ensure the safety of any activities to be conducted by it and its employees, affiliates, contractors or designees, with respect to handling and using EVMs. Further, user is responsible to ensure that any interfaces (electronic and/or mechanical) between EVMs and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
11. User shall employ reasonable safeguards to ensure that user's use of EVMs will not result in any property damage, injury or death, even if EVMs should fail to perform as described or expected.
12. User shall be solely responsible for proper disposal and recycling of EVMs consistent with all applicable federal, state, and local requirements.

Certain Instructions. User shall operate EVMs within TI's recommended specifications and environmental considerations per the user's guide, accompanying documentation, and any other applicable requirements. Exceeding the specified ratings (including but not limited to input and output voltage, current, power, and environmental ranges) for EVMs may cause property damage, personal injury or death. If there are questions concerning these ratings, user should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the applicable EVM user's guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using EVMs' schematics located in the applicable EVM user's guide. When placing measurement probes near EVMs during normal operation, please be aware that EVMs may become very warm. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use EVMs.

Agreement to Defend, Indemnify and Hold Harmless. User agrees to defend, indemnify, and hold TI, its directors, officers, employees, agents, representatives, affiliates, licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of, or in connection with, any handling and/or use of EVMs. User's indemnity shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if EVMs fail to perform as described or expected.

Safety-Critical or Life-Critical Applications. If user intends to use EVMs in evaluations of safety critical applications (such as life support), and a failure of a TI product considered for purchase by user for use in user's product would reasonably be expected to cause severe personal injury or death such as devices which are classified as FDA Class III or similar classification, then user must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

RADIO FREQUENCY REGULATORY COMPLIANCE INFORMATION FOR EVALUATION MODULES

Texas Instruments Incorporated (TI) evaluation boards, kits, and/or modules (EVMs) and/or accompanying hardware that is marketed, sold, or loaned to users may or may not be subject to radio frequency regulations in specific countries.

General Statement for EVMs Not Including a Radio

For EVMs not including a radio and not subject to the U.S. Federal Communications Commission (FCC) or Industry Canada (IC) regulations, TI intends EVMs to be used only for engineering development, demonstration, or evaluation purposes. EVMs are not finished products typically fit for general consumer use. EVMs may nonetheless generate, use, or radiate radio frequency energy, but have not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or the ICES-003 rules. Operation of such EVMs may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

General Statement for EVMs including a radio

User Power/Frequency Use Obligations: For EVMs including a radio, the radio included in such EVMs is intended for development and/or professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability in such EVMs and their development application(s) must comply with local laws governing radio spectrum allocation and power limits for such EVMs. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by TI unless user has obtained appropriate experimental and/or development licenses from local regulatory authorities, which is the sole responsibility of the user, including its acceptable authorization.

U.S. Federal Communications Commission Compliance

For EVMs Annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation. Changes or modifications could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at its own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Industry Canada Compliance (English)

For EVMs Annotated as IC – INDUSTRY CANADA Compliant:

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Concerning EVMs Including Radio Transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs Including Detachable Antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Canada Industry Canada Compliance (French)

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2014, Texas Instruments Incorporated

Important Notice for Users of EVMs Considered “Radio Frequency Products” in Japan

EVMs entering Japan are NOT certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If user uses EVMs in Japan, user is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after user obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after user obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless user gives the same notice above to the transferee. Please note that if user does not follow the instructions above, user will be subject to penalties of Radio Law of Japan.

<http://www.tij.co.jp>

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】本開発キットは技術基準適合証明を受けておりません。本製品のご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします

上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。

日本テキサス・インスツルメンツ株式会社

東京都新宿区西新宿6丁目24番1号

西新宿三井ビル

<http://www.tij.co.jp>

Texas Instruments Japan Limited

(address) 24-1, Nishi-Shinjuku 6 chome, Shinjuku-ku, Tokyo, Japan

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Applications Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Automotive and Transportation	www.ti.com/automotive
Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Video and Imaging	www.ti.com/video

TI E2E Community

e2e.ti.com